

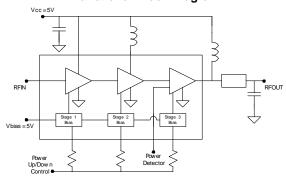
**Key Specifications** 

## **Product Description**

Sirenza Microdevices' SZM-3166Z is a high linearity class AB Heterojunction Bipolar Transistor (HBT) amplifier housed in a low-cost surface-mountable plastic Q-FlexN multi-chip module package. This HBT amplifier is made with InGaP on GaAs device technology and fabricated with MOCVD for an ideal combination of low cost and high reliability.

This product is specifically designed for 802.16 customer premise equipment (CPE) terminals in the 3.3-3.6 GHz bands. It can run from a 3V to 5.2V supply. The external output match and bias adjustability allows load line optimization for other applications covering 3.5-3.8GHz. It features an output power detector, on/off power control and high RF overdrive robustness. A 20dB step attenuator feature can be utilized by swtiching the second stage Power up/down control. This product features a RoHS compliant and Green package with matte tin finish, designated by the 'Z' suffix.

#### **Functional Block Diagram**



# SZM-3166Z

## 3.3-3.6GHz 2W Power Amplifier



# 6mm x 6mm QFN Package

#### **Product Features**

- P1dB =35dBm @ 5.2V
- Three Stages of Gain: 35dB
- 802.11g 54Mb/s Class AB Performance
- Pout = 27dBm @ 2.5% EVM, Vcc 5.2V,900mA
- **Active Bias with Adjustable Current**
- **On-chip Output Power Detector**
- **Low Thermal Resistance**
- Power up/down control  $< 1 \mu s$
- Attenuator Step 20dB @ Vpc2 = 0V
- Class 1C ESD Rating

### **Applications**

- 802.16 WiMAX Driver or Output Stage
- Fixed Wireless, WLL
- **CPE Terminal Applications**

Symbol	Parameters: Test Conditions, 3.3-3.6GHz App circuit, $Z_0 = 50\Omega$ , $V_{CC} = 5.2V$ , $Iq = 800mA$ , $T_{BP} = 30^{\circ}C$	Unit	Min.	Тур.	Max.
f <sub>O</sub>	Frequency of Operation	MHz	3300		3600
P <sub>1dB</sub>	Output Power at 1dB Compression – 3.5GHz	dBm		34.5	
S <sub>21</sub>	Gain @ Pout = 26dBm - 3.5GHz	dB	32	35	38
%	% EVM @ Pout = 27dBm, EVM 802.11g 54Mb/s - 3.5GHz	%		2.5	
IM3	Third Order Suppression (Pout=23dBm per tone) - 3.5GHz	dBc		-42	-37
NF	Noise Figure at 3.5 GHz	dB		5	
IRL	Worst Case Input Return Loss 3.3-3.6GHz	dB	11	14	
ORL	Worst Case Output Return Loss 3.3-3.6GHz	uБ	6	9	
Vcc	Supply voltage range	V		5.2	
Vdet Range	Output Voltage Range for Pout=10dBm to 33dBm	V		0.9 to 2.2	
I <sub>cq</sub>	Quiescent Current (V <sub>cc</sub> = 5.2V)	mA	720	800	880
I <sub>VPC</sub>	Power Up Control Current (V <sub>pc</sub> =5.2V) ( I <sub>VPC1</sub> +I <sub>VPC2</sub> + I <sub>VPC3</sub> )	mA		5	
I <sub>leak</sub>	Vcc Leakage Current (V <sub>cc</sub> = 5.2V, V <sub>pc</sub> = 0V)	mA			0.1
R <sub>th, j-l</sub>	Thermal Resistance (junction - lead)	°C/W		12	

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Phone: (800) SMI-MMIC

http://www.sirenza.com EDS-105462 Rev C



### Typical Performance 3.3-3.6GHz App Circuit (Vcc=5.2V, lcq=800mA, \* 802.11g 54Mb/s 64QAM)

Parameter	Units	3.3GHz	3.4GHz	3.5GHz	3.6GHz	3.7GHz	3.8GHz
Gain @ Pout=26dBm	dB	35	35	35	35	33	31.5
P1dB	dBm	34	34.5	35	34.5	34	33
% EVM @ Pout = 27dBm*	%	2.7	2.5	2.5	2.6	3.1	4
Current @ Pout 2.5% EVM*	mA	930	930	920	893	910	885
Input Return Loss	dB	14	15	15.5	17	18.5	15.5
Output Return Loss	dB	9	10	10	9	8	7

#### **Absolute Maximum Ratings**

Parameters	Value	Unit
VC3 Collector Bias Current (I <sub>VC3</sub> )	1500	mA
VC2 Collector Bias Current (I <sub>VC2</sub> )	600	mA
VC1 Collector Bias Current (I <sub>VC1</sub> )	300	mA
**Device Voltage (V <sub>D</sub> )	9.0	V
Power Dissipation	6	W
Operating Lead Temperature (T <sub>L</sub> )	-40 to +85	°C
*Max RF output Power for 50 ohm continuous long term operation	30	dBm
Max RF Input Power for 50 ohm output load	29	dBm
Max RF Input Power for 10:1 VSWR output load	5	dBm
Max Storage Temperature	+150	۰C
Operating Junction Temperature (T <sub>J</sub> )	+150	۰C
ESD Human Body Model	Class 1C	

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation the device voltage and current must not exceed the maximum operating values specified in the table on page one.

Bias conditions should also satisfy the following expression:  $I_{cq}V_{cc} < (T_J - T_L) \, / \, R_{TH'} \, j\text{--} I$  Note: lcq in this equation is for the stage with the highest current



#### **Caution: ESD Sensitive**

Appropriate precaution in handling, packaging and testing devices must be observed.

<sup>\*</sup> With specified application circuit.

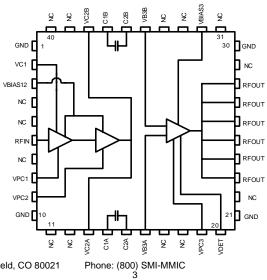
<sup>\*\*</sup> No RF Drive



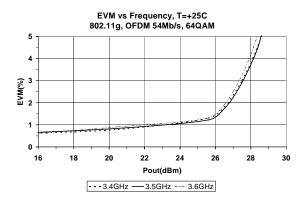
### **Pin Out Description**

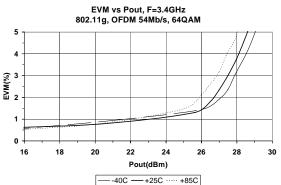
Pin #	Function	Description
5, 7, 11,12,17,18, 22, 29, 31, 33, 34, 39, 40	NC	These are no connect (NC) pins and are not wired inside the package. It is recommended to connect them as shown in the application circuit to achieve the stated performance.
1,10, 21, 30	GND	These pins are internally grounded inside the package to the backside ground paddle. It is recommended to also ground them external to the package to achieve the specified performance.
2	VC1	This is the collector of the first stage.
3	VBIAS12	This is the supply voltage for the active bias circuit of the 1st and 2nd stages.
4	NC	This pin is not connected inside the package, but it is recommended to connect it to GND to achieve the specified performance.
6	RFIN	This is the RF input pin. It is DC grounded inside the package. Do not apply DC voltage to this pin.
8	VPC1	Power up/down control pin for the 1st stage. An external series resistor is required for proper setting of bias levels depending on control voltage. The voltage on this pin should never exceed the voltage on pin 3 by more than 0.5V unless the supply current from pin 3 is limited < 10mA.
9	VPC2	Power up/down control pin for the 2nd stage. Power down VPC2<1V for step attenuator function enable. An external series resistor is required for proper setting of bias levels depending on control voltage. The voltage on this pin should never exceed the voltage on pin 3 by more than 0.5V unless the supply current from pin 3 is limited < 10mA.
13, 38	VC2A, VC2B	These two pins are connected internal to the package to the 2nd stage collector. To achieve specified performance, the layout of these pins should match the Recommended Land Pattern, pg. 9.
14,15, 36, 37	C1A,C2A C1B,C2B	These pins have capacitors across them internal to the package as shown in the below schematic. They are used as tuning and RF coupling elements between the 2nd and 3rd stage.
16,35	VB3A, VB3B	These are the connections to the base of the 3rd stage output device. To achieve specified performance, the layout of these pins should match the Recommended Land Pattern, pg. 9.
19	VPC3	Power up/down control pin for the 3rd stage. An external series resistor is required for proper setting of bias levels depending on control voltage. The voltage on this pin should never exceed the voltage on pin 32 by more than 0.5V unless the supply current from pin 33 is limited < 10mA.
20	VDET	This is the output port for the power detector. It samples the power at the input of the 3rd stage.
23-28	RFOUT	These are the RF output pins and DC connections to the 3rd stage collector.
32	VBIAS3	This is the supply voltage for the active bias circuit of the 3rd stage.

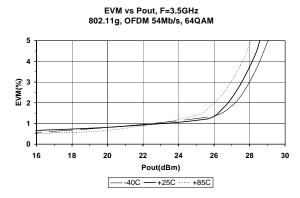
### **Simplified Device Schematic**

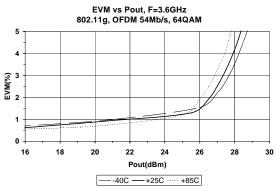


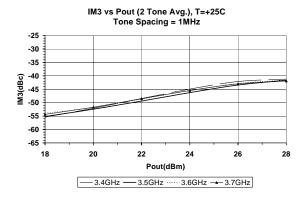


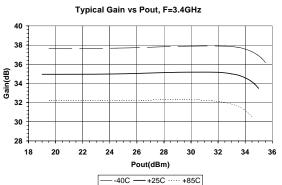




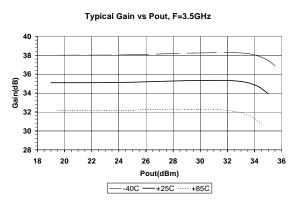


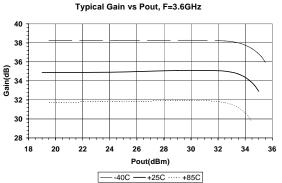


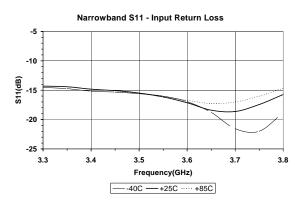


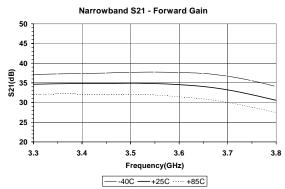


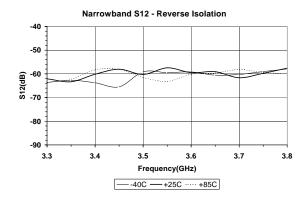


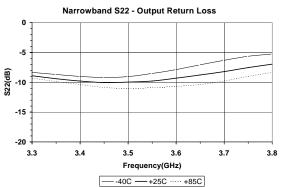




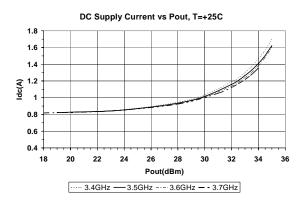


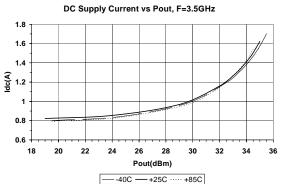


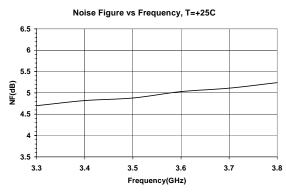


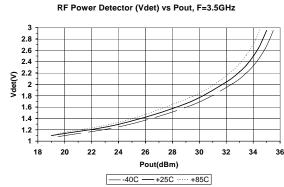


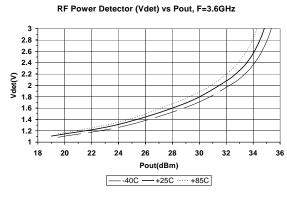


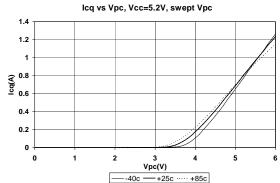




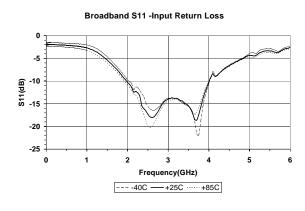


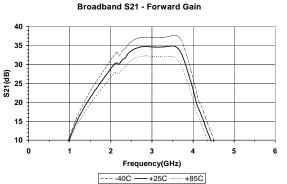


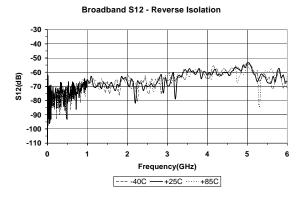


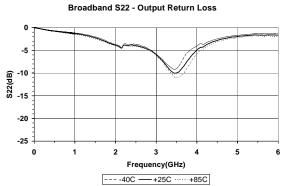


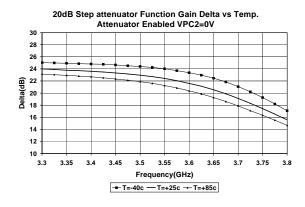






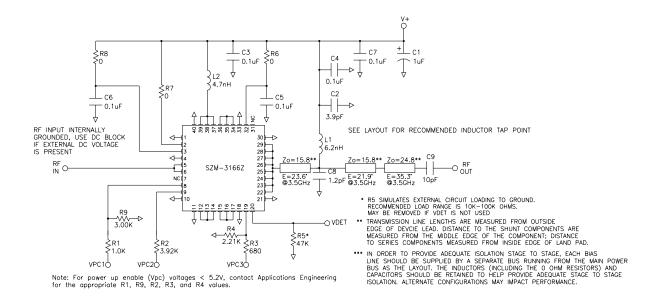






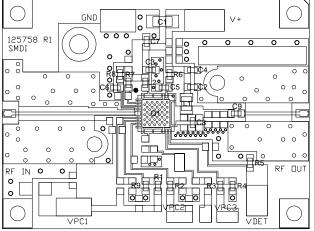


#### 3.3-3.6 GHz Evaluation Board Schematic For Vcc = Vpc =5.2V



#### 3.3-3.6 GHz Evaluation Board Layout For Vcc = Vpc = 5.2V

Board material GETEK, 10mil thick, Dk=3.9, 2 oz. copper



		.,
Q1	SZM-3166Z	6x6mm QFN
R1	1.0K OHM, 0603 1%	0402 may be used
R2	3.92K OHM, 0603 1%	*
R3	680 OHM, 0603 1%	*
R4	2.21K OHM, 0603 1%	*
R5	47K OHM, 0603	*
R6,7,8	0 OHM, 0603	"
R9	3K OHM, 0603 1%	"
C1	1uF 16V MLCC CAP	Tantalum ok for EVM performance Use MLCC type for best IM3 levels
C2	3.9pF CAP, 0603	NPO ROHM MCH185A3R9DK or equiv.
C3,4,5,6,7	0.1uF CAP, 0603	NPO 0402 ok ROHM MCH184CN105K or equiv.
C8	1.2pF CAP, 0603	NPO, low ESR ATC 600S1R5CW250 or equiv.
C9	10pF CAP, 0603	NPO, low ESR ATC 600S100JW250 or equiv.
L1	6.2nH IND 0805	Coilcraft 0805HQ - 6N2XJBB
L2	4.7nH IND, 0603	TOKO 0603 - LL1608FH4N7J

DESCRIPTION

NOTES

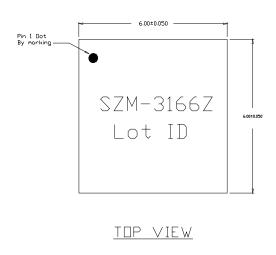
DESG



### **Part Symbolization**

The part will be symbolized with "SZM-3166Z" to designate it as a RoHs green compliant product. Marking designator will be on the top surface of the package.

### Package Outline Drawing (dimensions in mm):

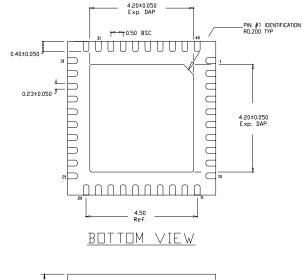


### Preliminary

### SZM-3166Z 3.3-3.6GHz 2W Power Amp

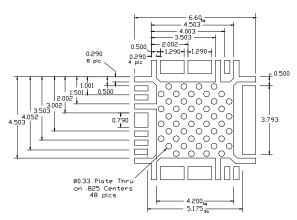
### Part Number Ordering Information

Part Number	Description	Reel Size	Reel Quantity		
SZM-3166Z	Lead Free, RoHS compliant	7"	1000		
SZM-3166Z-EVB1	3.3-3.6GHz Evaluation Board	N/A	N/A		





# Recommended Metal Land Pattern (dimensions in mm[in]):



# Recommended PCB Soldermask for Land Pattern (dimensions in mm[in]):

